Homework 1 on Electronic Devices in Silicon CMOS ICs

in the module

EEE201 CMOS Digital Integrated Circuits

1. In the MOS transistors of a digital integrated circuits (ICs), the drain diffusion region has an n-type doping of 10^{18} cm⁻³ on a silicon substrate with the p-type doping of 10^{16} cm⁻³.

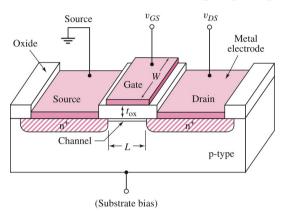


Image from: Donald A. Neamen, Microelectronics: Circuit Analysis & Design, 4th edition, © 2010 McGraw-Hill, USA.

- (a). What is the approximate intrinsic carrier concentration in silicon at room temperature (T = 300 K)? Hence or otherwise, calculate the **built-in potential** V_{bi} of the p-n junction between the p-type substrate and the n-type drain region at room temperature.
- (b). Using the result in (a) or otherwise, calculate the **depletion width** of the *p-n* junction when both the drain and the substrate are not connected to any voltage (i.e. zero-biased).
- (c). Using *Matlab* or *Excel*, plot a graph of the **depletion width** when the substrate is connected to ground and the drain voltage V_{DS} increases from 0 V to +3.0 V.
- (d). If the drain region of the MOSFET has a total area of 40 μ m \times 0.6 μ m, using the result in (b) or otherwise, calculate the **depletion capacitance** of the drain terminal in the open-circuit condition. Assume the sidewall contribution to the depletion capacitance negligible.
- (e). If the depth of the drain region is $0.15 \mu m$, calculate the sidewall contribution to the **depletion capacitance** in the open-circuit condition (i.e. zero-biased) (Hint: What is the perimeter of the drain region?).
- (f). Using *Matlab* or *Excel*, plot a graph of the total **depletion capacitance** (with the sidewall contribution included) when the substrate is connected to ground and the drain voltage V_{DS} increases from 0 V to +3.0 V.

Assume an abrupt junction (i.e. abrupt metallurgical boundary in the p-n junction) in all the calculations. Please find out the physical constants (e.g. Boltzmann's constant k_B) from textbooks or reliable websites on the internet.

- **2.** The MOS transistors of the same digital integrated circuits (ICs) described in Question 1 has a gate oxide thickness t_{ox} of 30 Å (i.e. 3.0 nm) and an effective channel length $L = 0.15 \mu m$.
 - (a). Calculate the <u>normalised</u> gate oxide capacitance C_{ox} of the MOS transistors. Assume the gate oxide is made of high quality silicon dioxide (SiO₂).

- (b). Determine the gate-to-source capacitance C_{GS} of the MOS transistor operating in the saturation region. Note that the MOSFET has $W = 40 \mu m$ and $L = 0.15 \mu m$.
- (c). Determine the gate-to-drain capacitance C_{GD} of the MOS transistor if it operates in the linear mode. How does the value of C_{GD} compare with the **depletion capacitance** of the drain-to-substrate junction?
- (d). It is given the electron mobility for the MOS transistors is 370 cm²/Vs and the **threshold voltage** V_T of the **n**-channel MOS transistors is 0.45 V. Assuming the long-channel approximation, using *Matlab* or *Excel*, plot a graph of the output characteristics (i.e. I_{DS} vs. V_{DS}) of a MOS transistor with a channel width W = 40 μ m and L = 0.15 μ m for V_{GS} = 0.7 V, 1.0 V, 1.5 V and 2.0 V while V_{DS} varies from 0 V to 2.5 V.
- (e). With the same parameters and the long-channel approximation, using *Matlab* or *Excel*, plot a graph of the **transfer characteristics** (i.e. I_{DS} vs. V_{GS}) of a MOS transistor of the same size W/L = 40 μ m/0.15 μ m for V_{DS} = 0.2 V, 1.0 V, 2.0 V while V_{GS} varies from 0 V to 2.0 V. Assume the current is zero when V_{GS} is below the **threshold voltage** V_{T} .
- (f). If hafnium oxide (HfO₂) with a dielectric constant of 25 is used to replace the silicon dioxide (SiO₂) as the gate dielectric, what would be the gate oxide thickness t_{HfO} to keep same the normalised **gate oxide capacitance** C_{ox} as that obtained in Q2(a)?

Note: In all the calculations, please show your steps clearly. When you find the values of some material parameters or physical constants (not provided in the questions), please cite the source(s) explicitly as a footnote or include a section of references at the end.